

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

Mechanical Data

Case: SOT-323

Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020D

Terminals: Solderable Per MIL-STD-202, Method 208

Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)

Terminal Connections: See Diagram

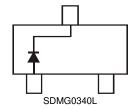
Marking Information: See Page 3

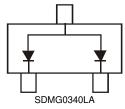
Ordering Information: See Page 3

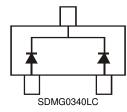
Weight: 0.006 grams (approximate)

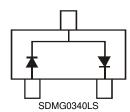


Top View









Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Forward Continuous Current (Note 1)	I _{FM}	30	mA
Non-Repetitive Peak Forward Surge Current @ t = 8.3ms	I _{FSM}	200	mA

Thermal Characteristics

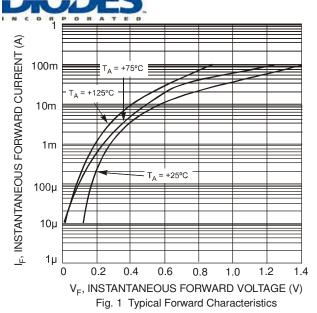
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-40 to +125	°C

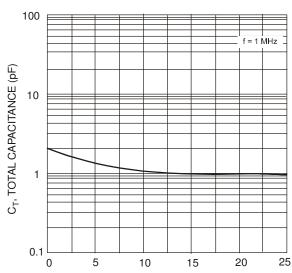
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	40			V	$I_R = 10\mu A$
Forward Voltage	V_{F}	_	295	370	mV	I _F = 1.0mA
Leakage Current (Note 2)	I _R	_	150	1000	nA	V _R = 10V
Total Capacitance	C _T	_	2.0	_	pF	$V_R = 1V, f = 1.0MHz$

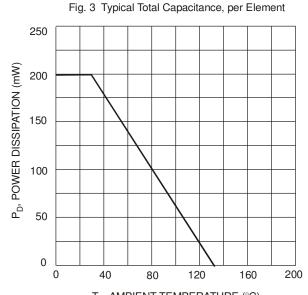
Notes:

- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- Short duration pulse test used to minimize self-heating effect.
- No purposefully added lead.
- Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



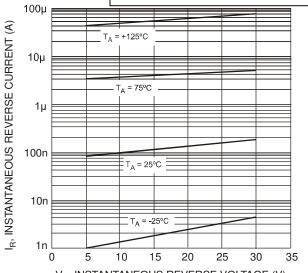


V_R, REVERSE VOLTAGE (V)



T_A, AMBIENT TEMPERATURE (°C) Fig. 5 Power Derating Curve, Total Package

SDMG0340L/LA/LC/LS



V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics

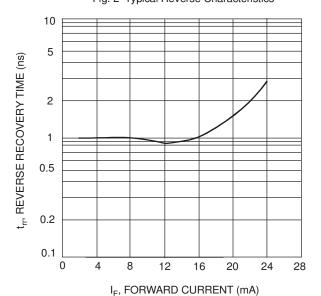


Fig. 4 Typical Reverse Recovery Time Characteristics

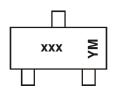


Ordering Information (Notes 5 & 6)

Device	Packaging	Shipping
SDMG0340L-7-F	SOT-323	3000/Tape & Reel
SDMG0340LA-7-F	SOT-323	3000/Tape & Reel
SDMG0340LC-7-F	SOT-323	3000/Tape & Reel
SDMG0340LS-7-F	SOT-323	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



xxx = Product Type Marking Code

KSM = SDMG0340L

KSQ = SDMG0340LA

KSP = SDMG0340LC

KSN = SDMG0340LS

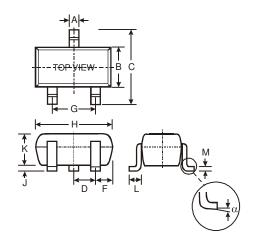
YM = Date Code Marking

Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Kev

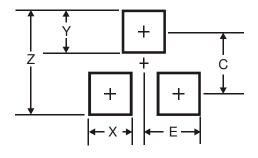
Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	М	N	Р	R	S	Т	U	V	W	X	Υ	Z	Α	В	С
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D

Package Outline Dimensions



SOT-323						
Dim	Min	Тур				
Α	0.25	0.40	0.30			
В	1.15 1.35 1.30					
С	2.00 2.20 2.10					
D	0.65					
F	F 0.30 0.40					
G	1.20	1.40	1.30			
Н	1.80 2.20		2.15			
J	J 0.0 0.10 0.05					
K	0.90	1.00	1.00			
L	0.25	0.40	0.30			
М	0.10	0.18	0.11			
α	0°	8°	-			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Υ	0.9
С	1.9
E	1.0





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